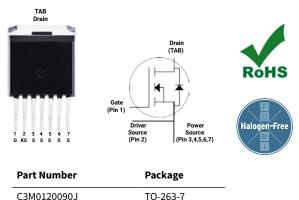


C3M0120090J

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology N-Channel Enhancement Mode

Features

- New C3M SiC MOSFET technology
- High blocking voltage with low On-resistance
- High speed switching with low capacitances
- New low impedance package with driver source
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Wide creepage (~7mm) between drain and source



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Typical Applications

- Renewable energy
- Lighting
- High voltage DC/DC converters
- Telecom Power Supplies
- Induction Heating

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note	
Drain - Source Voltage	V _{DS}			900		T _c = 25°C		
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient		
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1	
DC Continuous Drain Current	I _D			22	A	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25 \text{ °C}, \text{ T}_{J} \le 150 \text{ °C}$	Fig. 19 Note 2	
				14		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 150 \text{ °C}$		
Pulsed Drain Current	I _{DM}			50		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 °C$	Fig. 22	
Power Dissipation	P _D			83	w	$T_{c} = 25^{\circ}C, T_{J} = 150^{\circ}C$	Fig. 20	
Operating Junction and Storage Temperature	T _J , T _{stg}			-55 to +150	°C			
Solder Temperature	TL			260		According to JEDEC J-STD-020		

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	900	_	_		$V_{GS} = 0 V, I_{D} = 100 \mu A$		
	N	1.8	2.1	3.5	V	$V_{DS} = V_{GS}$, $I_D = 3 \text{ mA}$	Fi- 11	
Gate Threshold Voltage	V _{GS(th)}	_	1.6	_		V _{DS} = V _{GS} , I _D = 3 mA, T _J = 150°C	— Fig. 11	
Zero Gate Voltage Drain Current	I _{DSS}	_	1	100	μA	$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I _{GSS}	-	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	D	-	120	155	mΩ	$V_{GS} = 15 \text{ V}, I_{D} = 15 \text{ A}$	Fig. 4, 5, 6	
Drain-Source On-State Resistance	R _{DS(on)}	_	170	-	1117	$V_{GS} = 15 \text{ V}, I_{D} = 15 \text{ A}, T_{J} = 150^{\circ}\text{C}$		
Transasindustanas	-		8.9		S	V _{DS} = 15 V, I _{DS} = 15 A	— Fig. 7	
Transconductance	g _{fs}	-	7.1] —		V _{DS} = 15 V, I _{DS} = 15 A, T _J = 150°C		
Input Capacitance	C _{iss}	-	414	-			Fig. 17, 18	
Output Capacitance	C _{oss}	_	48	_	pF	$V_{GS} = 0 V, V_{DS} = 600 V$		
Reverse Transfer Capacitance	C _{rss}	_	3	_		f = 1 Mhz V _{AC} = 25 mV		
C _{oss} Stored Energy	E _{oss}	-	10.6	-			Fig. 16	
Turn-On Switching Energy	Eon	-	32	-	μJ	$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 15 \text{ A},$	Fig.	
Turn Off Switching Energy	E _{off}	-	8	-		$R_{G(ext)} = 2.5 \Omega, L = 99 \mu H, T_J = 150^{\circ}C$	26, 29	
Turn-On Delay Time	t _{d(on)}	-	5	-		$V_{11} = 400 V V_{12} = 4 V/15 V$		
Rise Time	tr	_	8	_	$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 15 \text{ A}, R_{G(ext)} = 2.5 \Omega,$		Fig.	
Turn-Off Delay Time	$t_{d(off)}$	_	13	_	ns	Timing relative to V _{DS}	27, 29	
Fall Time	t _f	_	4	_		Inductive load		
Internal Gate Resistance	R _{G(int)}	_	13	_	Ω	f = 1 MHz, V _{AC} = 25 mV		
Gate to Source Charge	Qgs	_	6	_	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$			
Gate to Drain Charge	Q _{gd}	_	5	_	nC	I _D = 15 A	Fig. 12	
Total Gate Charge	Qg	_	18	_		Per IEC60747-8-4 pg 21		

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Note	
Diode Forward Voltage	V _{SD}	4.8	_	V	$V_{GS} = -4 V$, $I_{SD} = 7.5 A$	Fig. 8, 9, 10	
		4.4	_		$V_{GS} = -4 V$, $I_{SD} = 7.5 A$, $T_{J} = 150^{\circ}C$		
Continuous Diode Forward Current	Is	-	15		$V_{GS} = -4 V$		
Diode Pulse Current	I _{S, pulsed}	-	50	A	V_{GS} = -4 V, pulse width t _P limited by T _{j max}		
Reverse Recover Time	t _{rr}	10	_	nS			
Reverse Recovery Charge	Q _{rr}	72	_	nC	C $V_{GS} = -4 V, I_{SD} = 15 A, V_{R} = 400 V$ dif/dt = 900 A/ μ s, T ₁ = 150°C		
Peak Reverse Recovery Current	I _{rrm}	23	_	А			

Thermal Characteristics

Parameter	Symbol	Мах	Unit	Note
Thermal Resistance from Junction to Case	$R_{\theta JC}$	1.5	°C ///	Fig. 21
Thermal Resistance From Junction to Ambient	$R_{\theta JA}$	40	°C/W	

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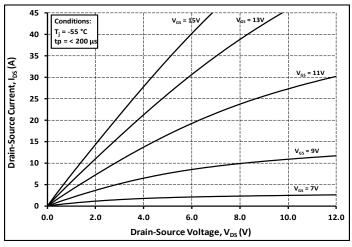
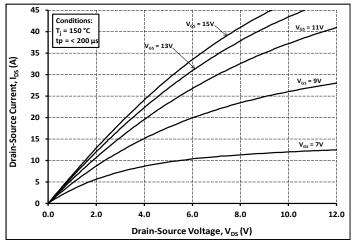
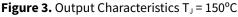
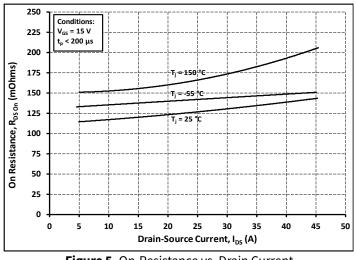
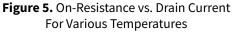


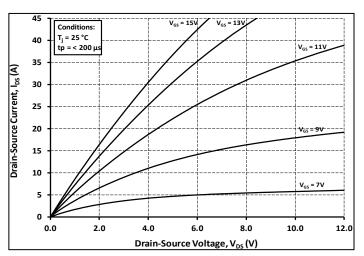
Figure 1. Output Characteristics T_J = -55°C

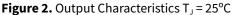












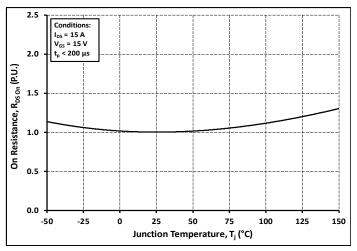


Figure 4. Normalized On-Resistance vs. Temperature

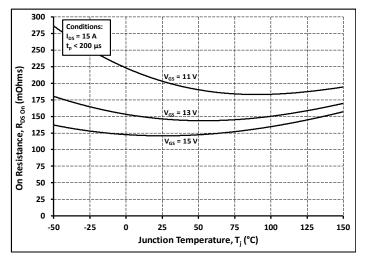
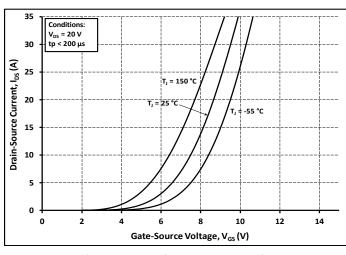


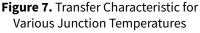
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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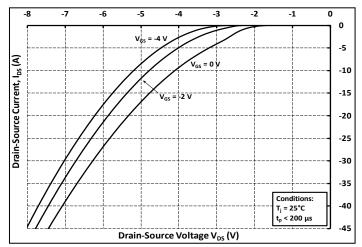
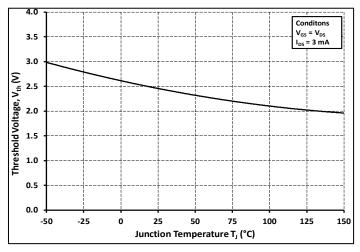
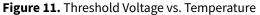
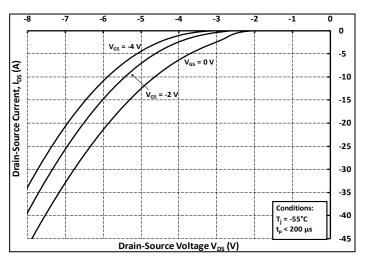
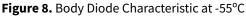


Figure 9. Body Diode Characteristic at 25°C









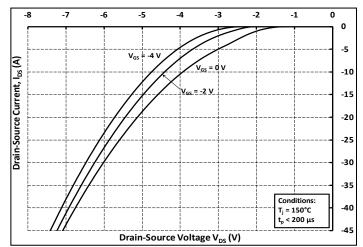
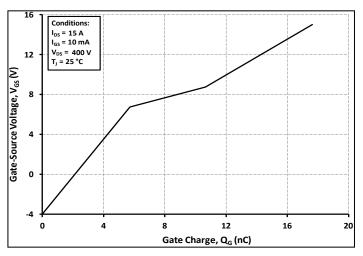
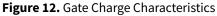


Figure 10. Body Diode Characteristic at 150°C





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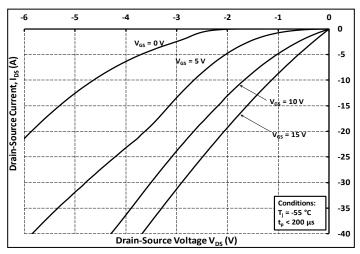


Figure 13. 3rd Quadrant Characteristic at -55°C

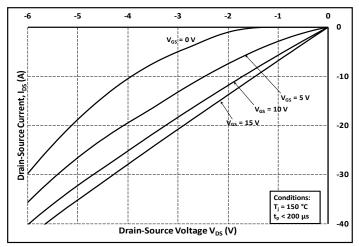


Figure 15. 3rd Quadrant Characteristic at 150°C

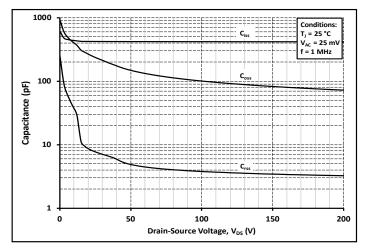


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200 V)

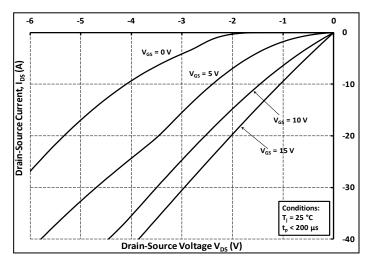


Figure 14. 3rd Quadrant Characteristic at 25°C

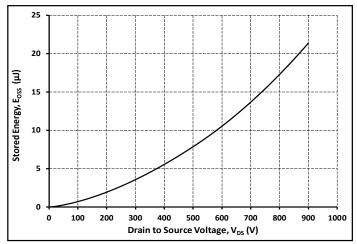


Figure 16. Output Capacitor Stored Energy

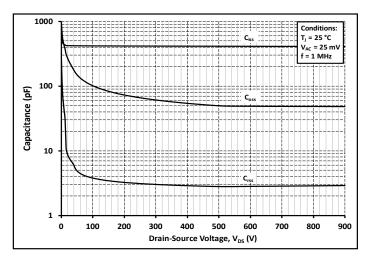
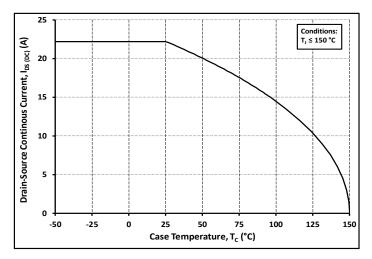


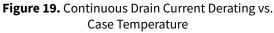
Figure 18. Capacitances vs. Drain-Source Voltage (0 - 900 V)

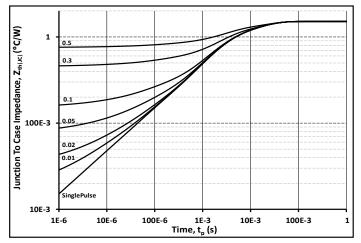
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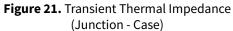
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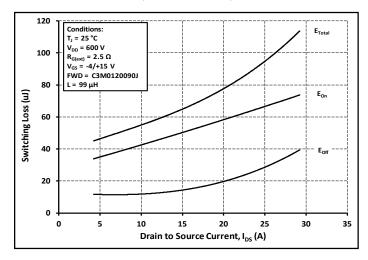


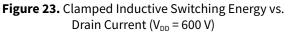












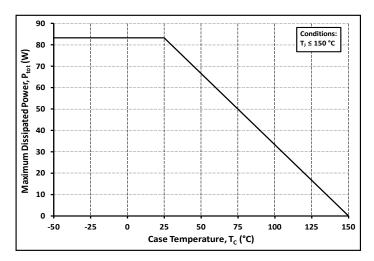


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

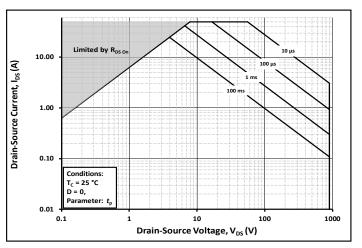


Figure 22. Safe Operating Area

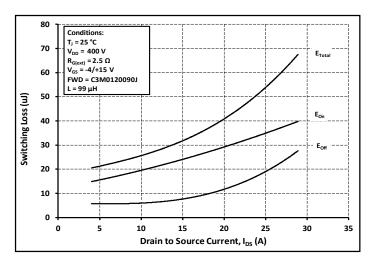


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 400 V)

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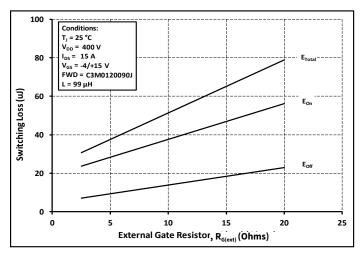


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

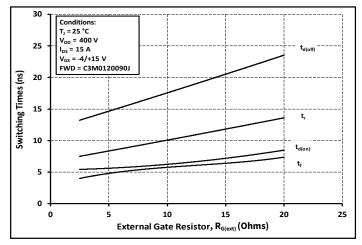


Figure 27. Switching Times vs. R_{G(ext)}

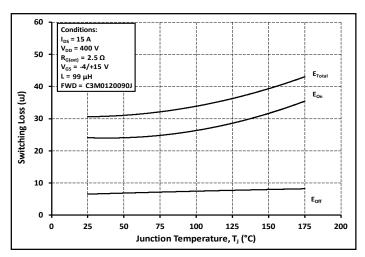


Figure 26. Clamped Inductive Switching Energy vs. Temperature

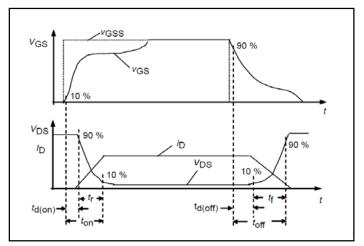


Figure 28. Switching Times Definition

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Test Circuit Schematic

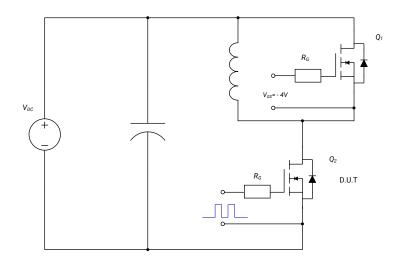


Figure 29. Clamped Inductive Switching Test Circuit

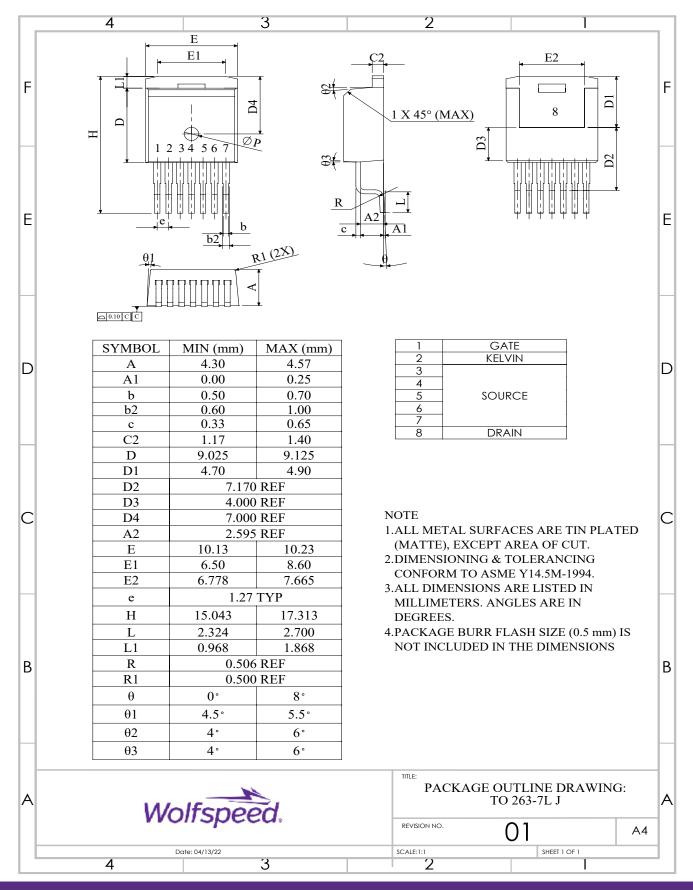
Note:

Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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Package Dimensions – Package TO-263-7

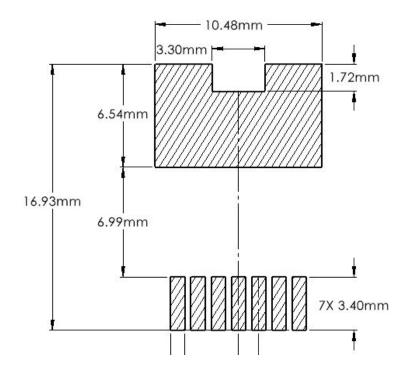


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Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes
2	October-2020	N/A
3	January-2024	Updated Wolfspeed branding, package drawing, package image, sol- der pad layout, added Rev history, Table 1 layout revised
4	December - 2024	Legal Disclaimer Updated

Related Links

- <u>SiC MOSFET Isolated Gate Driver reference design</u>
- <u>SiC MOSFET Evaluation Board</u>

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